

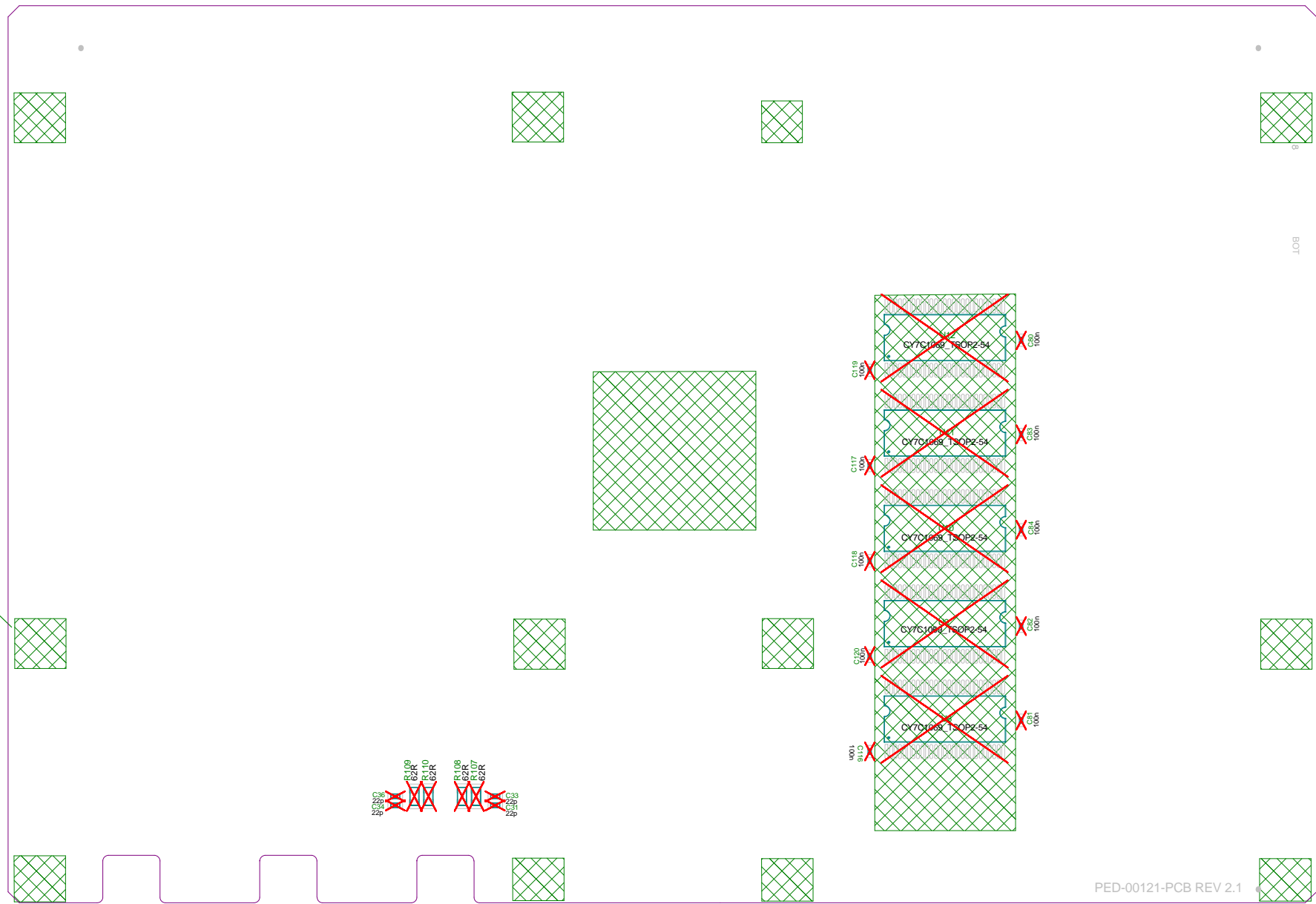
GERBER	LAYER
GM.	Mechanical 1
GBL	Bottom layer

Assembly Variant: Std_Build of GR-MCC-C_rev_3.0

Component Assembly Drawing : Reference Designators
 Component Assembly Drawing : Part Values

08/09/2011
 PED-00121-PCB REV 2.1
 PENDER ELECTRONIC DESIGN

PLEASE MASK HATCHED AREAS
 FOR WAVE SOLDERING OF BOTTOM



PED-00121-PCB REV 2.1

300

580

590

540

550

500

180

190

140

150

100

80

60

40

50

0

STÄTTLESTRASSE 8, ZÜRICH, SCHWEIZ www.pender.ch	PROJECT	GR-MCC-C	REV	2.1	DATE	08/09/2011	FILE NAME	PED-00121-PCB_Lev3-1.cpdoc
TITLE		MCC \ LEON3 Development Board						

